SIMADYN D Digital Control System

User Manual

Installation- and EMC Guidelines



User Manual, Installation- and EMC Guidelines

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We have checked the contents of this Manual to ensure that they coincide with the described hardware and software. However, deviations cannot be completely ruled-out, so we cannot guarantee complete conformance. However, the information in this document is regularly checked and the necessary corrections included in subsequent editions. We are thankful for any recommendations or suggestions.

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NOTE!

The information in this Manual does not purport to cover all details or variations in equipment, nor to provide for every possible contingency to be met in connection with installation, operation or maintenance.

Should further information be desired or should particular problems arise which are not covered sufficiently for the purchaser's purposes, please contact your local Siemens office.

Further, the contents of this Manual shall not become a part of or modify any prior or existing agreement, committment or relationship. The sales contract contains the entire obligation of Siemens. The warranty contained in the contract between the parties is the sole warranty of Siemens. Any statements contained herein do not create new warranties nor modify the existing warranty.

Warning information



Definitions

* QUALIFIED PERSONNEL

For the purpose of this User Manual and product labels, a "Qualified person" is someone who is familiar with the installation, mounting, start-up and operation of the equipment and the hazards involved. He or she must have the following qualifications:

1. Trained and authorized to energize, de-energize, clear, ground and tag circuits and equipment in accordance with established safety procedures.

2. Trained in the proper care and use of protective equipment in accordance with established safety procedures.

3. Trained in rendering first aid.

* DANGER

For the purpose of this User Manual and product labels, "Danger" indicates death, severe personal injury and/or substantial property damage will result if proper precautions are not taken.

* WARNING

For the purpose of this User Manual and product labels, "Warning" indicates death, severe personal injury or property damage can result if proper precautions are not taken.

* CAUTION

For the purpose of this User Manual and product labels, "Caution" indicates that minor personal injury or material damage can result if proper precautions are not taken.

* NOTE

For the purpose of this User Manual, "Note" indicates information about the product or the respective part of the User Manual which is essential to highlight.



CAUTION!

This board contains components which can be destroyed by electrostatic discharge. Prior to touching any electronics board, your body must be electrically discharged. This can be simply done by touching a conductive, grounded object immediately beforehand (e.g. bare metal cabinet components, socket protective conductor contact).

Δ	WARNING!
	Hazardous voltages are present in this electrical equipment during operation. Non-observance of the safety instructions can result in severe personal injury or
	It is especially important that the warning information in all of the relevant Operating Instructions are strictly observed.

1. Installation- and EMC guidelines

1.1. Introduction

These installation- and EMC guidelines supplement the documentation to the individual components. The SIMADYN D control system consists of individual components (e.g. subracks, boards, interface boards, operator control panels, position encoders). The components can be installed in the widest range of system configurations to fulfil individual demands - production, personnel and spatial. When the components are decentralized, a noisy environment cannot be neglected. Thus, special demands are placed on the installation and EMC of the overall system.

EMC is the capability of an electrical unit to be able to function, error and fault-free in an electromagnetic environment without influencing that environment inadmissibly.

Thus, EMC represents a quality feature for

- * noise immunity: Immune to internal electrical noise
- * external noise immunity: Immune to system-external electromagnetic noise
- * emission level: Influencing the environment as a result of electromagnetic radiation

In order to achieve the highest possible operational reliability and noise immunity of a complete system (closed-loop control and drive machine), the control manufacturer and user (including final customers), must apply certain measures.

The installation- and EMC guidelines for SIMADYN D are summarized in the following.

Perfect operation of SIMADYN D can only be guaranteed if all of these measures are observed.

1.2. Application and operation

SIMADYN D components are designed according to EN 50081-2 and EN 50082-2 for use in industrial environments. It is not permissible that they are operated from the public low-voltage supply network.

1.3. Machinery Directive

Corresponding to the Machinery Directive 89/392/EWG it should be observed, that the machine/system must not go into a hazardous state if SIMADYN D fails or malfunctions. This must be taken into account when configuring and designing the machine/system.

1.4. Low-Voltage Directive

The Low-Voltage Directive 73/23/EEC only involves products with supply voltages \geq 50V AC and/or >75V DC.

For SIMADYN D, the following products are involved:

- Prommer ext.	6DD 1672-0AD0
- SRT	6DD 1682-0FC0
- SP7	6DD 1683-0BB0
- SP8.5	6DD 1683-0BC0
- SP9.5	6DD 1683-0BE5
- SP 22.5	6DD 1683-0CC5
- SP 23.5	6DD 1683-0CD5
- SE 5.3	6DD 1681-0AF3
- SE 6.1	6DD 1681-0AG1
- SB 60	6DD 1681-0AF4
- SB 70	6DD 1681-0AG2

The above listed products conform to the specifications in the Low-Voltage Directive.

1.5. SIMADYN D outputs

When the power supply voltage is switched-on, the outputs have briefly undefined outputs while the power supply voltage establishes itself. This must be taken into account during the system design.

1.6. Specialist personnel

SIMADYN D may only be configured, installed, commissioned and operated by trained, specialist personnel.

1.7. CE mark

SIMADYN D components with the exception of the external programming unit, cannot have a CE mark, because

- they cannot be autonomously and practically used
- they are not generally (commercially) available,
- they may only be used by specially trained personnel
- they may not be used on the public low-voltage supply network

If required, the constructor of the complete installation/machine must take the necessary measures to be issued a CE mark.

1.8. Connecting-in external voltages

If external voltages are connected at SIMADYN D inputs (e.g. pulse encoders), which are supplied from an external power supply, then the external supply must also be shutdown when the SIMADYN D power supply is powered-down or fails.

1.9. Installation

SIMADYN D components must be mounted in a metal cabinet which is closed on all sides.

1.10. Cables

Only shielded signal cables may be connected to SIMADYN D.

1.11. Potential bonding

For fault-free operation, components which communicate or are coupled to each other, may not be at different potentials. Thus, all components must be connected through a potential bonding conductor (potential bonding).

1.12. Principle when connecting components

All components (subracks, power supplies etc), which are connected through signal cables, must be connected through potential bonding cables (exception: Components with fiber-optic cable connections).



1.13. Potential bonding bar

A potential equalization or grounding bar must be provided in each cabinet to simplify wiring and cabling.

All internal and external components must be connected to this potential bonding- or grounding bar.

Basic circuit







1.15. Protective grounding

The protective grounding is connected to the cabinets and components via the protective conductor (PE, old designation: SL). The potential bonding cable does not have a protective conductor function for SIMADYN D. For SIMADYN D, it is used to ensure reliable operation and as radio interference suppression.

The protective conductor must be routed according to DIN VDE 0100 and DIN VDE 0160. The cross-section for protective conductor connection at the subrack must be \geq 6 mm², and when connected to the cabinet, it must be \geq 10 mm².

1.16. Radio equipment

It is not permissible to use radio equipment > 2W in the direct vicinity of SIMADYN D. A clearance of > 1m to SIMADYN D must be maintained for low-rating radio equipment.

2. Cabinet

- * SIMADYN D components must always be installed in a metal cabinet
- * Every cabinet must have a ground/potential bonding bar which is connected at both ends to the cabinet frame.
- SIMADYN D subracks must be connected to the ground/potential bonding bar through a 6mm² cable, which should be kept as short as possible. It is not sufficient to establish a connection through the power supply PE connection.
- * No undamped contactors may be used in a cabinet with SIMADYN D components.
- * If undamped contactors are used in an adjacent cabinet to SIMADYN D, the cabinets must be provided with a shielding panel between them.
- * All cabinets involved in a networked SIMADYN D drive system must be connected with a 16 mm² potential bonding cable. (the customer-side PE connection is <u>not</u> adequate.)
- * Every cabinet with SIMADYN D components must have a shield connecting bar. The serrated-type bar is suitable. The shield connecting bar must be connected at both ends to the cabinet frame.
- * It is not permissible to use gas discharge lamps in the cabinet.
- * The shields of incoming as well as outgoing cables must be connected directly to the shield bar.
- * The cabinets should be designed so that air can freely circulate in them.

2.1. Unit clearances

It is not permissible to mount SIMADYN D subracks close together. Minimum clearances must be maintained in a $2200 \times 600 \times 600$ mm cabinet.



2.2. Power loss in the cabinet

Dependent on the selected design

- 1) Open frame
- 2) Cabinet with air mesh
- 3) Enclosed cabinet with forced convection
- 4) Enclosed cabinet with heat exchanger

then different maximum temperature values are obtained for the SIMADYN D components used.



The power loss which can be dissipated from a cabinet is dependent on the cabinet design, its ambient temperature and the layout of the equipment in the cabinet.





Recommended values for the permissible ambient temperature for a 600 mm x 600 mm x 220 mm cabinet as a function of the installed power loss, can be taken from Fig. 1.

- 1) Open unit/wall
- 2) Cabinet with air intake slots
- 3) Enclosed cabinet with natural convection and forced air circulation using a fan
- 4) Enclosed cabinet with heat exchanger

If a cabinet is ventilated from below through the cable duct, then more favorable conditions are obtained as shown under 2).

For mounting types 1) and 2), it is assumed that there is at least 1 m clearance between the top of the cabinet and the ceiling.

3. Power supply

* Measures against noise voltages

The following noise suppression information/instructions should be observed so that noise voltage spikes are eliminated in the cabinet supply cables.

* Suppressing line feeder cables

A filter (e.g. B84299-K64, 250 V AC / 10 A) should be installed in the cable, as close as possible to the cable entry for 115/230 V supplies in the cabinet. The line filter ground connection must be connected to the central cabinet grounding point through the shortest possible cable.

* Discharge capacitors for DC power supplies

If a cabinet is connected to a central 24 V supply, noise voltages can enter the cabinet via the power supply cable (cable-borne).

It is recommended that noise-suppression capacitors are mounted where the 24 V supply enters the cabinet. The capacitors should be mounted on the cabinet ground or the shield connecting bar.

- * The power supply connections may <u>not</u> be directly taken from the SITOR set (commutating dips), but must be taken from a "clean", filtered source.
- * If several 24 V power supplies are used in networked systems, the various grounds must be connected through the ground/potential bonding bar and connected to the subracks.

Caution!

Protective separation according to VDE 0160 must be guaranteed for all power supply units, which are used to supply SIMADYN D equipment and boards.

* Power supply potentials

For SIMADYN D, the grounds of all secondary voltages are connected together and connected with the subrack housing, and are thus grounded, to improve noise signal discharge.



* Supply from clocked power supplies

If a clocked power supply is used for the 24 V power supply input, the rated power of the power supply must be designed for the SIMADYN D inrush current (200% rated current). Otherwise, the clocked power supply could reach the short-circuit current limiting resulting in undefined statuses.

4. Subracks

- * The subracks must be connected to the ground/potential bonding bar through the shortest possible cable with a minimum cross-section of 6mm².
- * All boards must be tightly screwed into the subrack also during start-up!!
- * Empty slots must be provided with SIMADYN D front slot covers.
- * If boards are used in adapters during start-up, the front panel must be connected with the subrack through the shortest possible cable.
- * It is not permissible to withdraw or insert boards under voltage.
- * The connectors for serial interfaces, pulse encoders and SITOR set must be tightly screwed to the front panel.
- * The maximum temperature of the air drawn into the subrack is 55 degrees C. The subrack must be mounted, so that air can circulate freely. Heat build-up must be prevented.
- * The air drawn into the subrack must be clean.

5. Boards

5.1. CS11, CS21 rack coupling

- * All of the subracks must be connected with one another through the grounding/potential bonding bar through the shortest possible connections, even if the subracks are mounted in the same cabinet.
- * Shielded, round cables must be used for the connecting cables between CS11 and CS21. The shields must be connected at both ends at the ground/shield bar.
- The maximum cable length is 50 m when routing in non-shielded cable ducts with a 30 cm clearance to other cables.
 The maximum cable length is 100 m when separately routed in shielded cable ducts or pipes.
- * The cables should be as short as possible. It is not permissible to roll-up longer cable lengths.

5.2. PS, PG processor boards

- * Shielded, round cables must be used for the connecting cables between the PGx and SITOR set or Pgx and SE21.x. The maximum cable length is 30 m, whereby the shield must be connected to ground at both ends. The cable must have twisted pairs.
- * The PS16 frequency inputs must be connected through a shielded round cable. The shield should be connected to ground at both ends.

5.3. Memory modules

The label supplied must be attached to the MS x program memory module after it has been programmed.
 These labels do not have to be attached to the MS x modules for test software during the start-up

These labels do not have to be attached to the MS x modules for test software during the start-up phase.

5.4. PM13 - SE1.1 setpoint cascade

- * All of the subracks must be connected through the shortest possible connection via the grounding/potential bonding bar, even if the subracks are mounted in the same cabinet.
- * Shielded, round cables must be used as setpoint cascade signal cables.

e.g. Scotchflex MT round cable

20 core No. 36 59-20 40 core No. 36 59-40

from 3M

- * The shields of the 20-core connecting cables between the SE1.1 boards must be connected to the ground/shield bar at both ends. The maximum cable length is 30 m.
- * Shielded, round cables must also be used for the 40-core cable from PM13 to SE1.1. The shield must be connected to the ground/shield bar.
- * The 40-core pre-assembled cable, SC38 6DD1684-0DJ0 can be used as connecting cable.

6. Cables

- * Cables for the power supply, digital signal cables for DC, and digital signal cables for AC and analog signal cables must be routed separately.
- * Cables entering from outside (e.g. to the terminal modules), may not be routed together in a common cable duct with internal cabinet wiring.
- * The shields of incoming shielded cables (analog and binary) must be connected to the shield bar where the cable enters the cabinet. The cable should then be routed, shielded to the terminal module/board. Shields are not connected to the terminal modules/boards.
- * Serial connecting cables must be shielded. The shield must be connected to the metalized connector housing. Further, it must be connected to the shield bar. The cable shield may not be connected at connector, pin 1. Shielding via the board front panels is ineffective.
- * The cable shields must be connected, at both ends to the shield bars in the cabinet.
- * Shielded cables must be used for analog signal lines, both in the cabinet as well as outside the cabinets.
- $\ast\,$ Cable shields connected at one end to ground. For analog signal lines, for low voltage or current signals (MV or μA), then the cable shield must be connected at one end to the shield bar in the cabinet.
- * All digital signal cables must be shielded.

Max. Cable length

Board	Cable length (m) shielded
Outputs	1000
Inputs 220V AC	1000
Inputs 2460V DC	1000

* A minimum clearance of >10 cm must be maintained between signal cables and power cables under 500 V AC, and >30 cm for power cables above 1 kV AC.

7. Mounting SIMADYN D units in drive converters

The following points must be observed when mounting SIMADYN D boards in 6RA24 and 6SE12/13 drive converters:

- * The tachometer cables of the pulse encoders should have double shields for cable lengths >10 m.
- * Only SIMADYN D terminal modules and cables must be used.
- * All of the cable shields must be connected to a shield bar through the largest possible area. The shield bar should be grounded using the shortest possible connection with a min. 10 mm² cross-section.
- * For 6SE12/13, the motor cables as well as the cables to the external braking resistor, must be shielded.
- * The drive converters should not be mounted/installed in the vicinity of radio transmitter aerials.
- * The units must always be mounted in a metal cabinet which is enclosed on all sides.

8. ESD guidelines

8.1. What is ESD?

Almost all SIMADYN D boards have highly-integrated devices. These devices are, from their very priniciple, sensitive to overvoltages and therefore to electrostatic discharge.

ESD: <u>E</u>LECTRO<u>S</u>TATIC <u>D</u>ISCHARGE

Boards, which use such devices, have a warning label on the component mounting side:



ESD components can be destroyed by voltages and energy levels which lie far below the perception level of human beings. Voltages such as these occur, if a component or a board is touched by a person who was not previously electrostatically discharged. Devices, which are subject to these types of overvoltages, generally cannot be immediately identified as having been damaged as incorrect functioning is only manifested after a somewhat longer operating time.

8.2. Handling ESD boards

- * Electronic boards should only be touched/handled if absolutely necessary.
- * Components/devices may only be touched/handled if
 - you are continuously grounded through an ESD arm band
 - or you are wearing ESD shoes or ESD shoe grounding strips.
- * The human body must be electrically discharged before touching/handling an electronics board. This can be simply done by touching a conductive, grounded object immediately beforehand (e.g. bare metal cabinet parts, water pipes etc.).
- * Boards may not come into contact with highly-insulating materials which can be statically chargedup - e.g. plastic foils, insulating desktops, articles of clothing manufactured from man-made fibers.
- * Boards may only be placed down on conductive surfaces (desktop with ESD surface, conductive ESD foam rubber, ESD packing bags, ESD transport containers, board- or paper surfaces).
- * It is not permissible to bring boards into the vicinity of monitors or TV sets.

8.3. Measuring and modifying ESD boards

- * Measurements may only be carried-out on boards if
 - the measuring unit is grounded (via the protective conductor) or
 - before making a measurement with an ungrounded instrument, the probe must be briefly discharged (e.g. by briefly touching a bare-metal control housing).
- * When soldering, only a grounded soldering iron may by used.

8.4. Shipping ESD boards

Boards and devices may only be stored or shipped in conductive packing materials (e.g. metalized plastic boxes, impregnated cardboard).

If the packaging is not conductive, the boards must be placed in a conductive material before packing. This could be, for example, conductive foam rubber, ESD bags, household aluminum foil or paper (no plastic bags of foils).

The jumper connectors must be removed if a SIMADYN D processor board is located in the associated socket.

The subrack is supplied with all of the plug connectors.

9. ESD instructions

a = Conductive floor surface

b = ESD table

c = ESD shoes

Components which can be destroyed by electrostatic discharge (ESD)

Generally, electronic boards should only be touched when absolutely necessary.

The human body must be electrically discharged before touching an electronics board. This can be simply done by touching a conductive, grounded object directly beforehand (e.g. bare metal cubicle components, socket outlet protective conductor contact).

Boards must not come into contact with highly-insulating materials - e.g. plastic foils, insulated desktops, articles of clothing manufactured from man-made fibers.

Boards must only be placed on conductive surfaces.

When soldering, the soldering iron tip must be grounded.

Boards and components should only be stored and transported in conductive packaging (e.g. metalized plastic boxes, metal containers).

If the packing material is not conductive, the boards must be wrapped with a conductive packing material, e.g. conductive foam rubber or household aluminum foil.

d = ESD overall

f = Cabinet ground connection

e = ESD chain

The necessary ESD protective measures are clearly shown in the following diagram.



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System-Based Drive Technology

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